

HCT60R180-S2

	HCT60R180-S2
	600V N-Channel Super Junction Power MOSFET

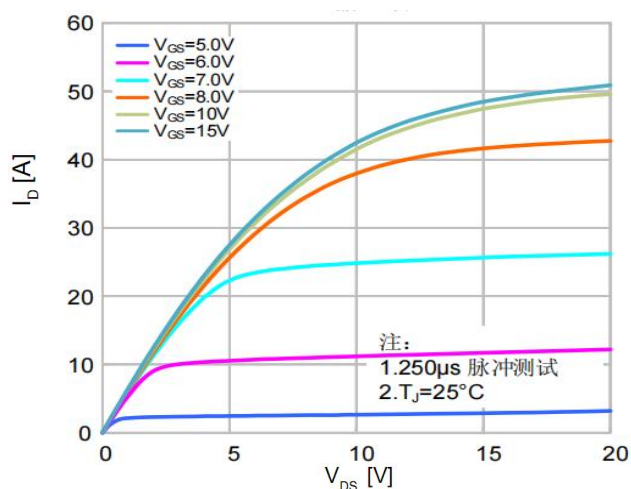
Electrical Characteristics(Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditons	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-source Breakdown Voltage	V _{GS} =0V ,I _D =250μA	600	--	--	V
ΔBV _{DSS} /ΔT _J	Breakdown Voltage Temperature Coefficient	I _D =250μA (Referenced to 25°C)	--	0.60	--	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V,V _{GS} =0V	--	--	1	μA
		V _{DS} =480V,Tc=125°C	--	--	10	μA
I _{GSSF}	Gate-Body Leakage Current,Forward	V _{GS} =+30V, V _{DS} =0V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current,Reverse	V _{GS} =-30V, V _{DS} =0V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250μA	2.0	--	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10 V, I _D =10.0A	--	160	190	mΩ
g _{FS}	Forward Transconductance	V _{DS} =20 V, I _D =10.0A (Note4)	--	10.7	--	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =100V,V _{GS} =0V, f=1.0MHz	--	1175	--	pF
C _{oss}	Output Capacitance		--	53	--	pF
C _{rss}	Reverse Transfer Capacitance		--	1.1	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 300 V, I _D = 20 A, R _G = 25 Ω (Note4,5)	--	22	--	ns
t _r	Turn-On Rise Time		--	51	--	ns
t _{d(off)}	Turn-Off Delay Time		--	79	--	ns
t _f	Turn-Off Fall Time		--	38	--	ns
Q _g	Total Gate Charge	V _{DS} = 480 V, I _D =20.0 A, V _{GS} = 10 V (Note4,5)	--	31	--	nC
Q _{gs}	Gate-Source Charge		--	9.6	--	nC
Q _{gd}	Gate-Drain Charge		--	14	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	20	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	80	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} =0V,I _S =20.0A	--	--	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V, I _S =20.0A, d I _F /dt=100A/μs (Note4)	--	290	--	ns
Q _{rr}	Reverse Recovery Charge		--	4.2	--	μC

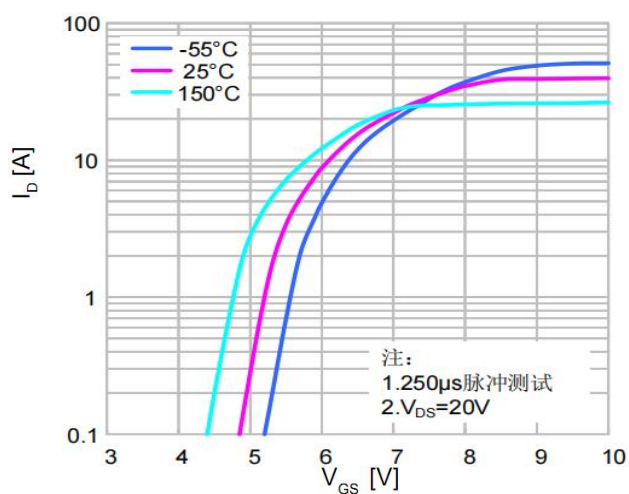
Notes:

- 1、Repetitive Rating:Pulse Width Limited by Maximum Junction Temperature.
- 2、L = 20mH, $I_{AS}=4.0A$, $V_{DD}=100V$, $R_G=25\Omega$, Starting $T_J=25^\circ C$.
- 3、 $I_{SD}\leq 20.0A$, $di/dt\leq 200A/\mu s$, $V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ C$.
- 4、Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
- 5、Essentially Independent of Operating Temperature.

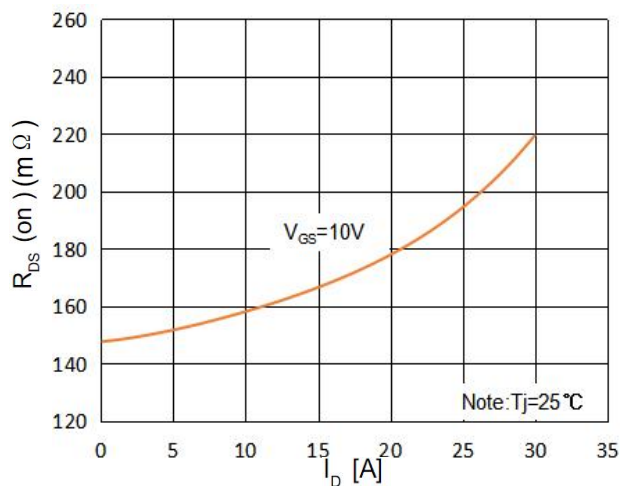
On-Regin Characteristics



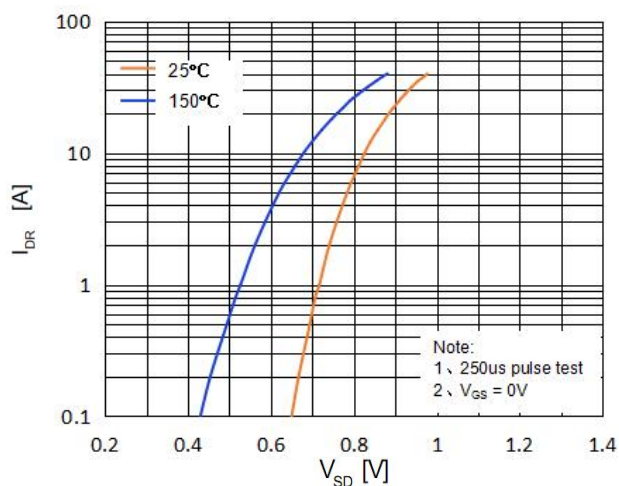
Transfer Characteristics



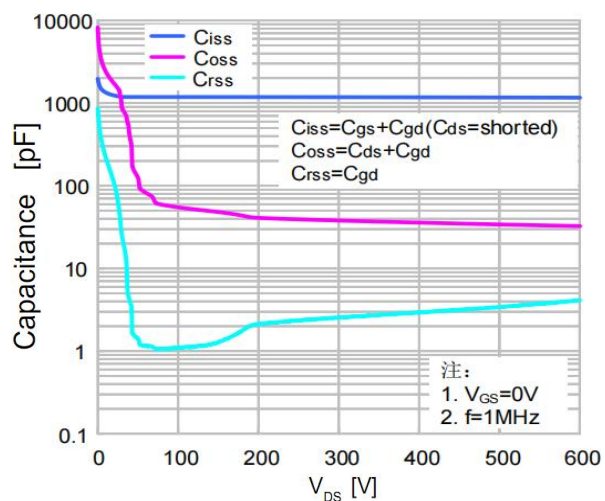
On-Resistance Variation vs. Drain Current and Gate Voltage



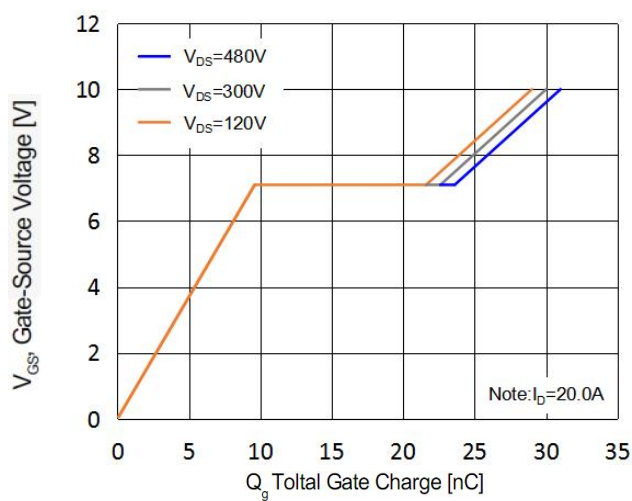
Body Diode Forward Voltage Variation vs. Source Current and Temperature



Capacitance Characteristics



Gate Charge Characteristics

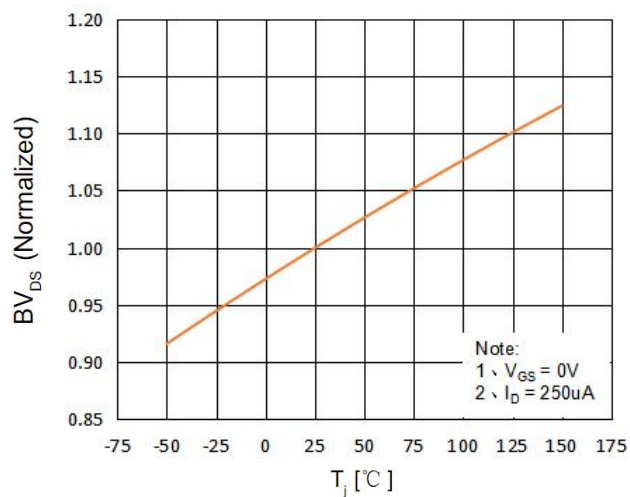




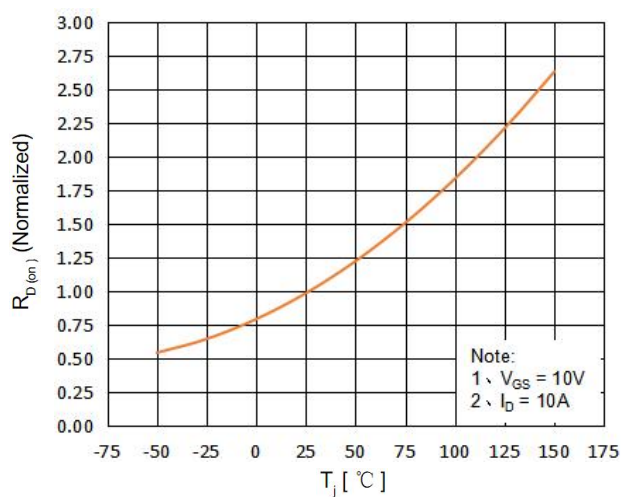
HCT60R180-S2

600V N-Channel Super Junction Power MOSFET

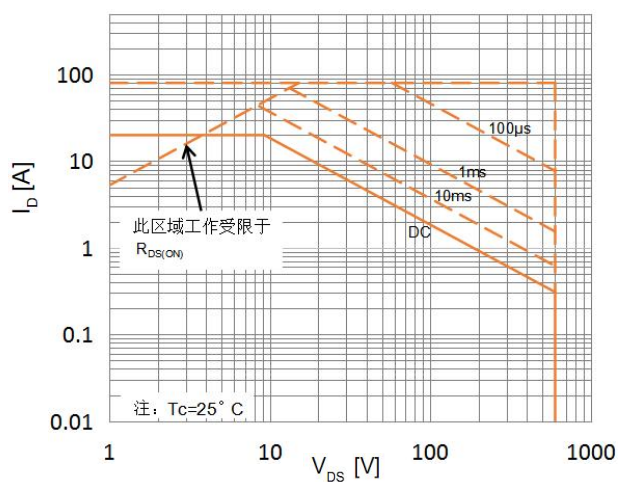
**Breakdown Voltage Variation
vs. Temperature**



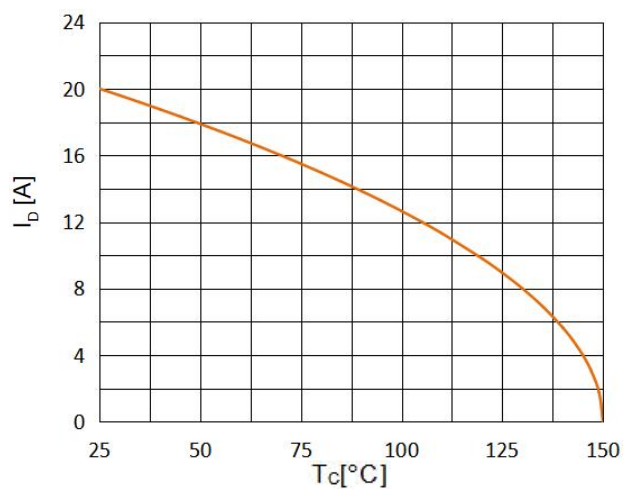
**On-Resistance Variation
vs. Temperature**



Maximum Safe Operating Area



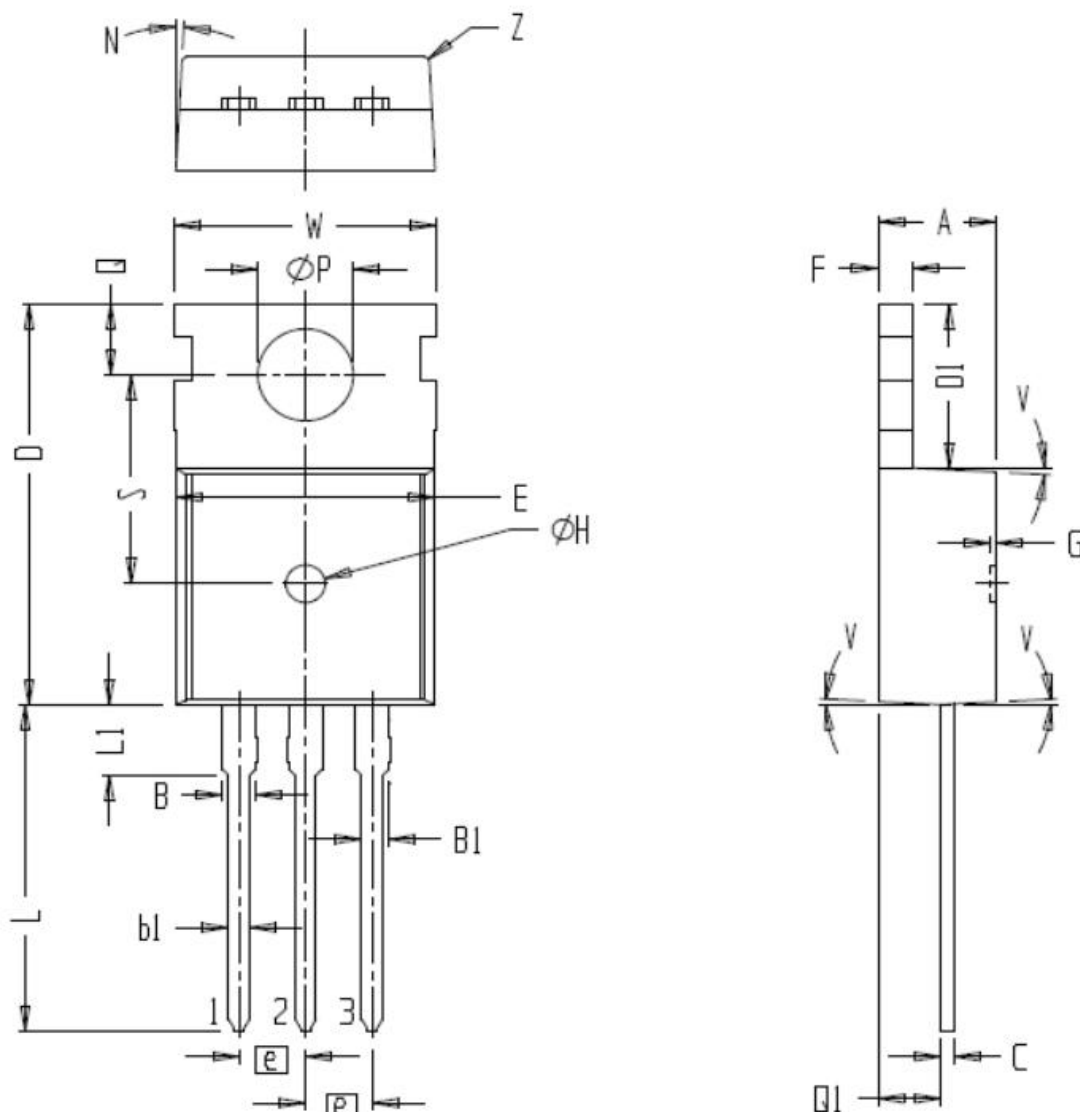
**Maximum Drain Current
Vs. Case Temperature**



TO-220C Package Dimensions

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	4.00	4.40	4.80	E	9.40	9.90	10.40
B	1.17	1.32	1.47	e		2.54	
B1	0.91	1.06	1.21	F	1.15	1.30	1.45
b1	0.65	0.80	0.95	L	12.00	13.00	14.00
c	0.40	0.50	0.60	L1	2.50	3.00	3.50
D	14.90	15.90	16.90	Q	2.30	2.80	3.30
D1	6.10	6.60	7.10	Q1	1.90	2.40	2.90
W	9.50	10.00	10.50	ϕP	3.40	3.65	3.90
S		8.30		Z	0		0.20
ϕH		1.50		N		3 °	
G		0.10		V		3 °	



	HCT60R180-S2
	600V N-Channel Super Junction Power MOSFET

注意事项：

- 1、在电路设计时请不要超过器件的最大额定值，否则会影响整机的可靠性。
- 2、MOSFET产品为静电敏感型器件，使用时应注意采取防静电保护措施，如佩戴防静电手环、设备接地等。
- 3、如需安装散热片，请注意控制扭力大小及散热片的平整度。
- 4、该规格书由华科公司制作，并可能不定期更改，恕不另行通知。
- 5、如有疑问，请及时联系我司销售代表。

版本履历表：

序号	版本号	修改时间	修改记录
1	V1.0	2023-3-28	首次发行